



**Fast Thyristor  
Type TFI333-400-15**

Low switching losses  
Low reverse recovery charge  
Distributed amplified gate for high  $di_T/dt$

Mean on-state current	$I_{TAV}$	400 A		
Repetitive peak off-state voltage	$V_{DRM}$	1000 ÷ 1500 V		
Repetitive peak reverse voltage	$V_{RRM}$			
Turn-off time	$t_q$	16.0; 20.0; 25.0; 32.0 $\mu$ s		
$V_{DRM}, V_{RRM}, V$	1000	1200	1400	1500
Voltage code	10	12	14	15
$T_{j}, ^\circ C$	- 60 ÷ 125			

**MAXIMUM ALLOWABLE RATINGS**

Symbols and parameters		Units	Values	Test conditions
<b>ON-STATE</b>				
$I_{TAV}$	Mean on-state current	A	400 645	$T_c = 90^\circ C$ ; Double side cooled; $T_c = 55^\circ C$ ; Double side cooled; 180° half-sine wave; 50 Hz
$I_{TRMS}$	RMS on-state current	A	628	$T_c = 90^\circ C$ ; Double side cooled; 180° half-sine wave; 50 Hz
$I_{TSM}$	Surge on-state current	kA	7.0 8.0	180° half-sine wave; 50 Hz ( $t_p = 10$ ms); single pulse; $V_D = V_R = 0$ V; Gate pulse: $I_G = I_{FGM}$ ; $V_G = 20$ V; $t_{GP} = 50 \mu$ s; $di_G/dt = 1$ A/ $\mu$ s
			8.0 9.2	180° half-sine wave; 60 Hz ( $t_p = 8.3$ ms); single pulse; $V_D = V_R = 0$ V; Gate pulse: $I_G = I_{FGM}$ ; $V_G = 20$ V; $t_{GP} = 50 \mu$ s; $di_G/dt = 1$ A/ $\mu$ s
$I^2t$	Safety factor	$A^2s \cdot 10^3$	245 320	180° half-sine wave; 50 Hz ( $t_p = 10$ ms); single pulse; $V_D = V_R = 0$ V; Gate pulse: $I_G = I_{FGM}$ ; $V_G = 20$ V; $t_{GP} = 50 \mu$ s; $di_G/dt = 1$ A/ $\mu$ s
			265 350	180° half-sine wave; 60 Hz ( $t_p = 8.3$ ms); single pulse; $V_D = V_R = 0$ V; Gate pulse: $I_G = I_{FGM}$ ; $V_G = 20$ V; $t_{GP} = 50 \mu$ s; $di_G/dt = 1$ A/ $\mu$ s
<b>BLOCKING</b>				
$V_{DRM}, V_{RRM}$	Repetitive peak off-state and Repetitive peak reverse voltages	V	1000÷1500	$T_{j \min} < T_j < T_{j \max}$ ; 180° half-sine wave; 50 Hz; Gate open
$V_{DSM}, V_{RSM}$	Non-repetitive peak off-state and Non-repetitive peak reverse voltages	V	1100÷1600	$T_{j \min} < T_j < T_{j \max}$ ; 180° half-sine wave; 50 Hz; single pulse; Gate open
$V_D, V_R$	Direct off-state and Direct reverse voltages	V	0.75· $V_{DRM}$ 0.75· $V_{RRM}$	$T_j = T_{j \max}$ ; Gate open

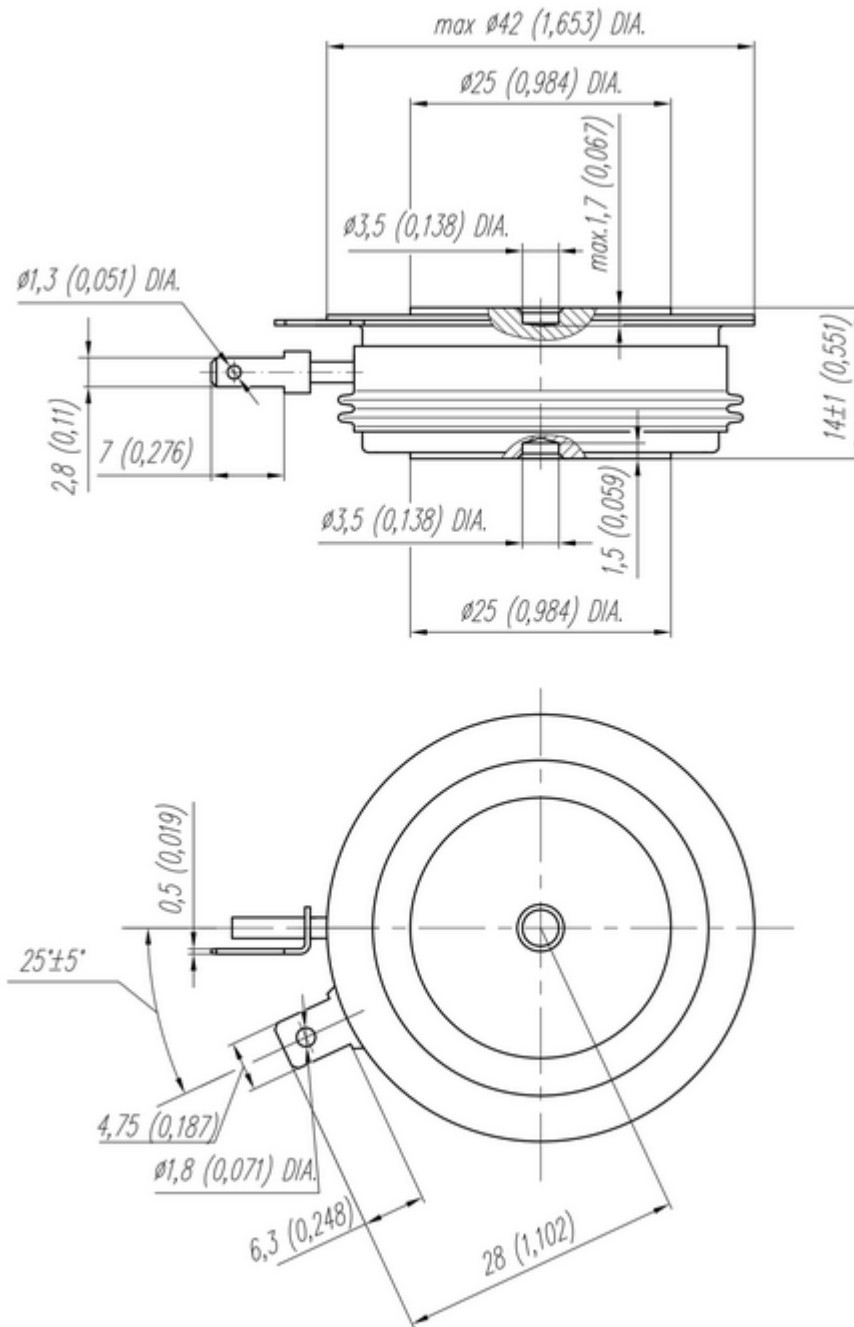
<b>TRIGGERING</b>				
$I_{FGM}$	Peak forward gate current	A	6	$T_j = T_{j\ max}$
$V_{RGM}$	Peak reverse gate voltage	V	5	
$P_G$	Gate power dissipation	W	3	$T_j = T_{j\ max}$ for DC gate current
<b>SWITCHING</b>				
$(di_T/dt)_{crit}$	Critical rate of rise of on-state current non-repetitive (f=1 Hz)	A/ $\mu$ s	1600	$T_j = T_{j\ max}$ ; $V_D = 0.67 \cdot V_{DRM}$ ; $I_{TM} = 2 I_{TAV}$ ; Gate pulse: $I_G = I_{FGM}$ ; $V_G = 20$ V; $t_{GP} = 50$ $\mu$ s; $di_G/dt = 1$ A/ $\mu$ s
<b>THERMAL</b>				
$T_{stg}$	Storage temperature	$^{\circ}$ C	-60 ÷ 125	
$T_j$	Operating junction temperature	$^{\circ}$ C	-60 ÷ 125	
<b>MECHANICAL</b>				
F	Mounting force	kN	9.0 ÷ 11.0	
a	Acceleration	m/s <sup>2</sup>	50 100	Device unclamped Device clamped

## CHARACTERISTICS

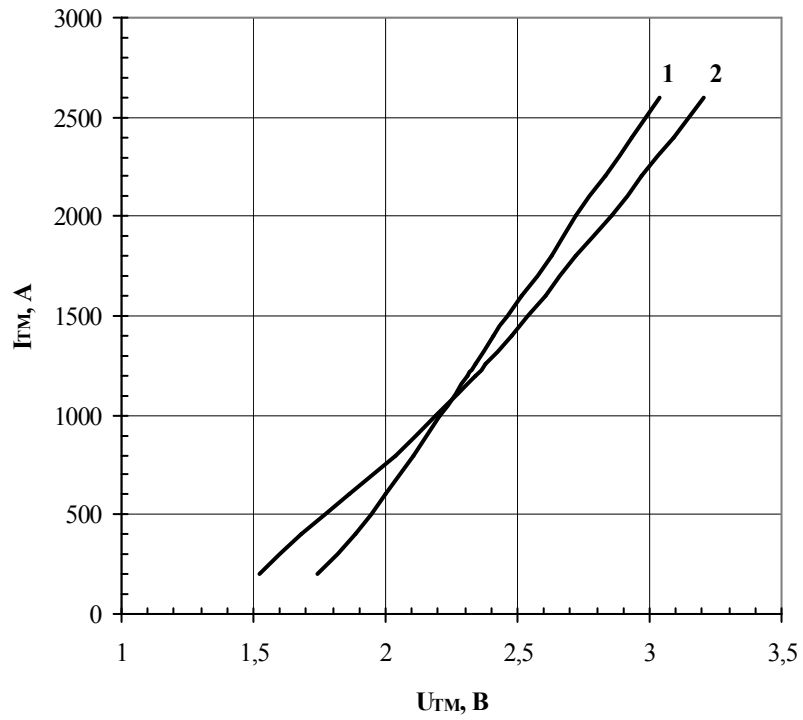
Symbols and parameters		Units	Values	Conditions	
<b>ON-STATE</b>					
$V_{TM}$	Peak on-state voltage, max	V	2.40	$T_j = 25$ $^{\circ}$ C; $I_{TM} = 1256$ A	
$V_{T(TO)}$	On-state threshold voltage, max	V	1.35	$T_j = T_{j\ max}$ ; $0.5 \pi I_{TAV} < I_T < 1.5 \pi I_{TAV}$	
$r_T$	On-state slope resistance, max	m $\Omega$	0.85		
$I_H$	Holding current, max	mA	500	$T_j = 25$ $^{\circ}$ C; $V_D = 12$ V; Gate open	
<b>BLOCKING</b>					
$I_{DRM}$ , $I_{RRM}$	Repetitive peak off-state and Repetitive peak reverse currents, max	mA	50	$T_j = T_{j\ max}$ ; $V_D = V_{DRM}$ ; $V_R = V_{RRM}$	
$(dv_D/dt)_{crit}$	Critical rate of rise of off-state voltage <sup>1)</sup> , min	V/ $\mu$ s	1000	$T_j = T_{j\ max}$ ; $V_D = 0.67 \cdot V_{DRM}$ ; Gate open	
<b>TRIGGERING</b>					
$V_{GT}$	Gate trigger direct voltage, max	V	4.00 2.50 2.00	$T_j = T_{j\ min}$ $T_j = 25$ $^{\circ}$ C $T_j = T_{j\ max}$	$V_D = 12$ V; $I_D = 3$ A; Direct gate current
$I_{GT}$	Gate trigger direct current, max	mA	500 300 200	$T_j = T_{j\ min}$ $T_j = 25$ $^{\circ}$ C $T_j = T_{j\ max}$	
$V_{GD}$	Gate non-trigger direct voltage, min	V	0.25	$T_j = T_{j\ max}$ ; $V_D = 0.67 \cdot V_{DRM}$ ;	
$I_{GD}$	Gate non-trigger direct current, min	mA	10.00	Direct gate current	
<b>SWITCHING</b>					
$t_{gd}$	Delay time	$\mu$ s	2.00	$T_j = 25$ $^{\circ}$ C; $V_D = 0.4 \cdot V_{DRM}$ ; $I_{TM} = I_{TAV}$ ; Gate pulse: $I_G = I_{FGM}$ ; $V_G = 20$ V; $t_{GP} = 50$ $\mu$ s; $di_G/dt = 1$ A/ $\mu$ s	
$t_q$	Turn-off time <sup>2)</sup> , max	$\mu$ s	16.0; 20.0; 25.0; 32.0	$dv_D/dt = 50$ V/ $\mu$ s	$T_j = T_{j\ max}$ ; $I_{TM} = 400$ A; $di_R/dt = -10$ A/ $\mu$ s; $V_R = 100$ V; $V_D = 0.67 V_{DRM}$
			20.0; 25.0; 32.0; 40.0	$dv_D/dt = 200$ V/ $\mu$ s	
$Q_{rr}$	Total recovered charge, max	$\mu$ C	150	$T_j = T_{j\ max}$ ; $I_{TM} = 400$ A;	
$t_{rr}$	Reverse recovery time, typ	$\mu$ s	3.2	$di_R/dt = -50$ A/ $\mu$ s;	
$I_{rrM}$	Peak reverse recovery current, max	A	94	$V_R = 100$ V	

<b>THERMAL</b>					
$R_{thjc}$	Thermal resistance, junction to case, max	°C/W	0.0400	Direct current	Double side cooled
$R_{thjc-A}$			0.0880		Anode side cooled
$R_{thjc-K}$			0.0720		Cathode side cooled
$R_{thck}$	Thermal resistance, case to heatsink, max	°C/W	0.0060	Direct current	
<b>MECHANICAL</b>					
w	Weight, typ	g	110		
$D_s$	Surface creepage distance	mm (inch)	10.30 (0.405)		
$D_a$	Air strike distance	mm (inch)	6.30 (0.248)		

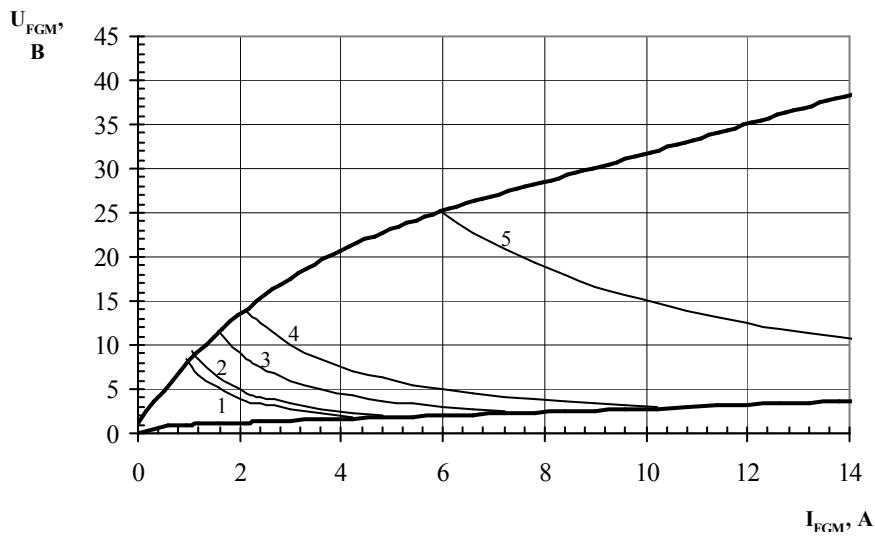
<b>NOTES</b>		<b>PART NUMBERING GUIDE</b>																								
<sup>1)</sup> Critical rate of rise of off-state voltage <table border="1"> <tr> <td>Symbol of group</td> <td>A2</td> </tr> <tr> <td><math>(dv_D/dt)_{crit}</math>, V/μs</td> <td>1000</td> </tr> </table>		Symbol of group	A2	$(dv_D/dt)_{crit}$ , V/μs	1000	<table border="1"> <tr> <td>TFI</td> <td>333</td> <td>400</td> <td>15</td> <td>A2</td> <td>T3</td> <td>N</td> </tr> <tr> <td>1</td> <td>2</td> <td>3</td> <td>4</td> <td>5</td> <td>6</td> <td>7</td> </tr> </table>							TFI	333	400	15	A2	T3	N	1	2	3	4	5	6	7
Symbol of group	A2																									
$(dv_D/dt)_{crit}$ , V/μs	1000																									
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<sup>2)</sup> Turn-off time ( $dv_D/dt=50$ V/μs) <table border="1"> <tr> <td>Symbol of group</td> <td>T3</td> <td>P3</td> <td>M3</td> <td>K3</td> </tr> <tr> <td><math>t_{qr}</math>, μs</td> <td>16.0</td> <td>20.0</td> <td>25.0</td> <td>32.0</td> </tr> </table>		Symbol of group	T3	P3	M3	K3	$t_{qr}$ , μs	16.0	20.0	25.0	32.0	<ol style="list-style-type: none"> <li>TFI — Fast Thyristor TFIS — Fast Thyristor with Distributed Amplified Gate</li> <li>Design version</li> <li>Mean on-state current, A</li> <li>Voltage code</li> <li>Critical rate of rise of off-state voltage</li> <li>Group of turn-off time (<math>dv_D/dt=50</math> V/μs)</li> <li>Ambient conditions: N – normal; T – tropical</li> </ol>														
Symbol of group	T3	P3	M3	K3																						
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All dimensions in millimeters (inches)



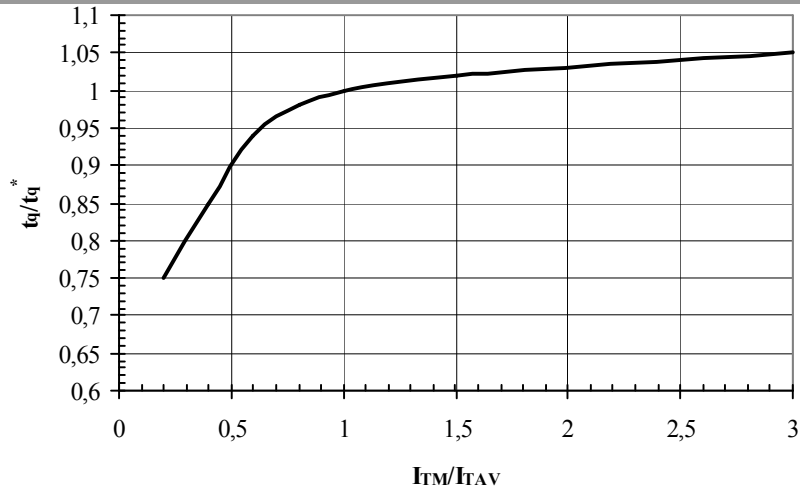
**Fig. 1** On-state characteristics of Limit device  
 1 -  $T_j = 25\text{ °C}$   
 2 -  $T_j = 125\text{ °C}$



Maximum peak gate power loss

Position	On-Off time ratio	Gate pulse length, ms	Gate Pulse Power, W
1	1	DC	8
2	2	10	10
3	20	1	18
4	40	0.5	30
5	200	0.1	150

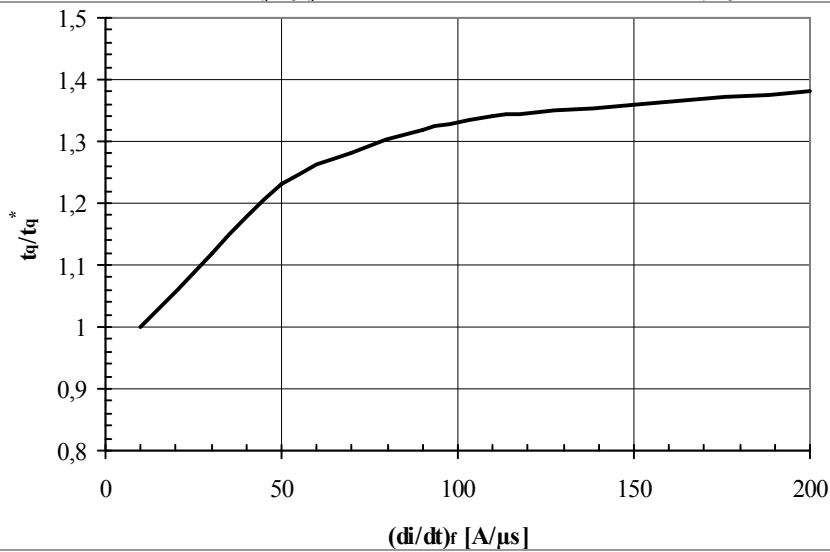
**Fig. 2** Gate characteristics



**Fig. 3** Turn-off time  $t_q$  vs. On-state peak current  $I_{TM}$

Conditions:  $T_j=T_{j\ max}$ ;  $di_R/dt=10\ A/\mu s$ ;  $V_R=100\ V$ ;  $dv_D/dt=50\ V/\mu s$ ;  $V_D=0.67\cdot V_{DRM}$

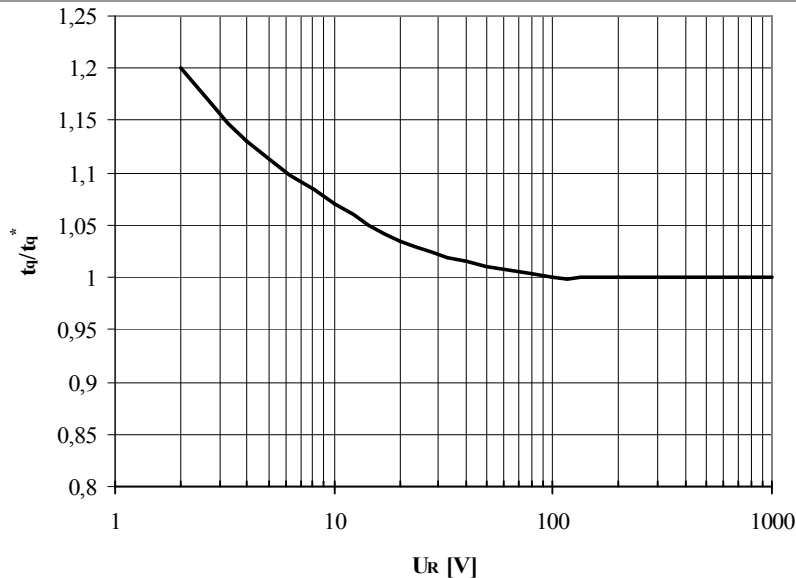
Typical changes of  $t_q$  are normalized to the  $t_q^*$  ( $t_q^*$  – see data sheet,  $dv_D/dt=50\ V/\mu s$ )



**Fig. 4** Turn-off time  $t_q$  vs. Rate of fall of on-state current  $di_R/dt$

Conditions:  $T_j=T_{j\ max}$ ;  $I_{TM}=I_{TAV}$ ;  $V_R=100\ V$ ;  $dv_D/dt=50\ V/\mu s$ ;  $V_D=0.67\cdot V_{DRM}$

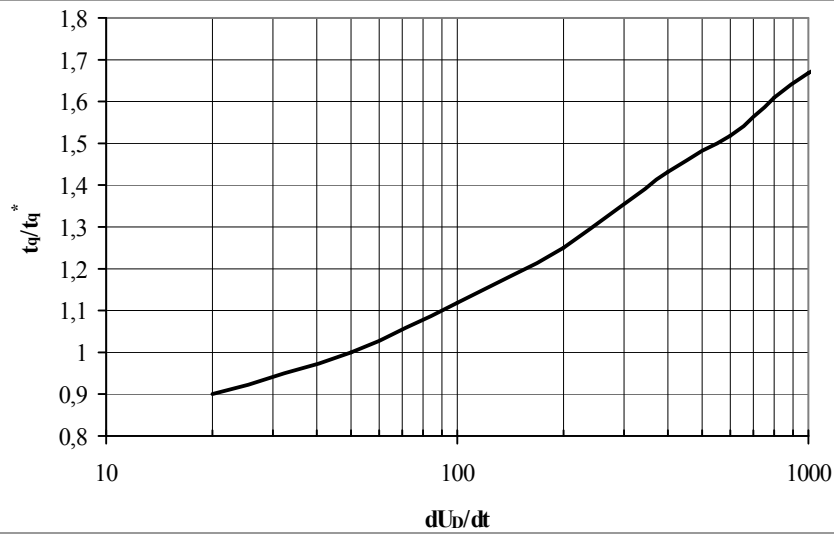
Typical changes of  $t_q$  are normalized to the  $t_q^*$  ( $t_q^*$  – see data sheet,  $dv_D/dt=50\ V/\mu s$ )



**Fig. 5** Turn-off time  $t_q$  vs. Reverse voltage  $V_R$

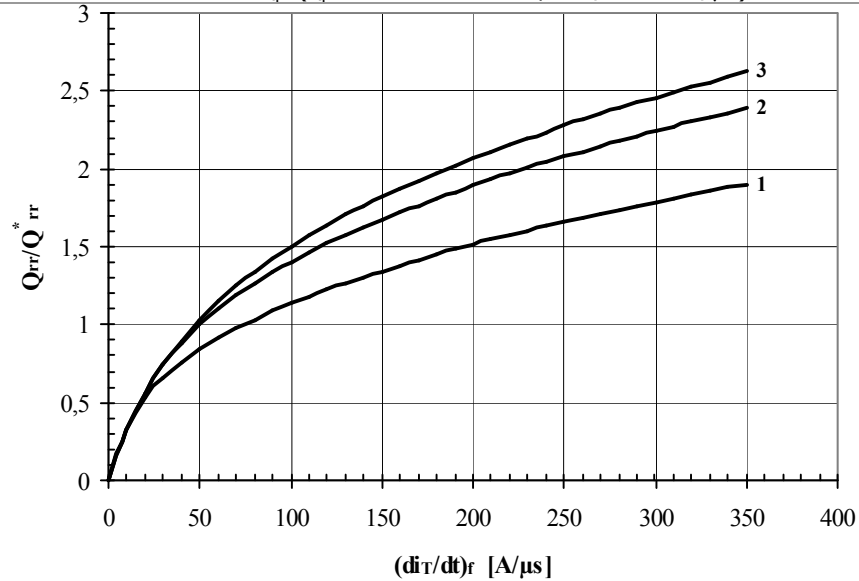
Conditions:  $T_j=T_{j\ max}$ ;  $I_{TM}=I_{TAV}$ ;  $di_R/dt=10\ A/\mu s$ ;  $dv_D/dt=50\ V/\mu s$ ;  $V_D=0.67\cdot V_{DRM}$

Typical changes of  $t_q$  are normalized to the  $t_q^*$  ( $t_q^*$  – see data sheet,  $dv_D/dt=50\ V/\mu s$ )



**Fig. 6** Turn-off time  $t_q$  vs. Rate of rise of commutating voltage  $dv_D/dt$

Conditions:  $T_j = T_{j\max}$ ;  $I_{TM} = I_{TAV}$ ;  $di_R/dt = 10 \text{ A}/\mu\text{s}$ ;  $V_R = 100 \text{ V}$ ;  $V_D = 0.67 \cdot V_{DRM}$   
 Typical changes of  $t_q$  are normalized to the  $t_q^*$  ( $t_q^*$  – see data sheet,  $dv_D/dt = 50 \text{ V}/\mu\text{s}$ )

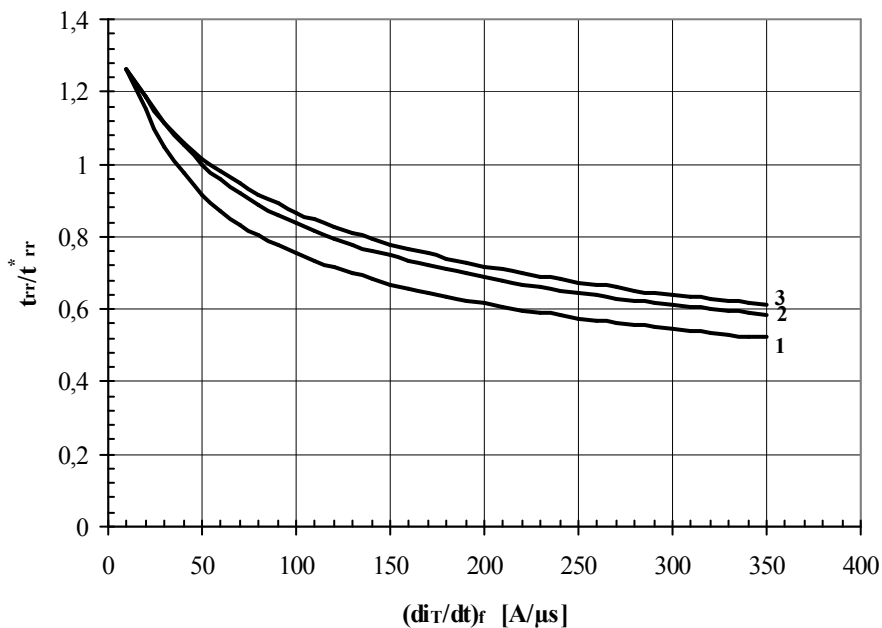


**Fig. 7** Reverse recovery charge  $Q_{rr}$  vs. Rate of fall of on-state current  $di_R/dt$

- 1 –  $I_{TM} = 0.5 \cdot I_{TAV}$
- 2 –  $I_{TM} = I_{TAV}$
- 3 –  $I_{TM} = 1.5 \cdot I_{TAV}$

Conditions:  $T_j = T_{j\max}$ ;  $V_R = 100 \text{ V}$

Typical changes of  $Q_{rr}$  are normalized to the  $Q_{rr}^*$  ( $Q_{rr}^*$  – see data sheet)



**Fig. 8** Reverse recovery time  $t_{rr}$  vs. Rate of fall of on-state current  $di_R/dt$

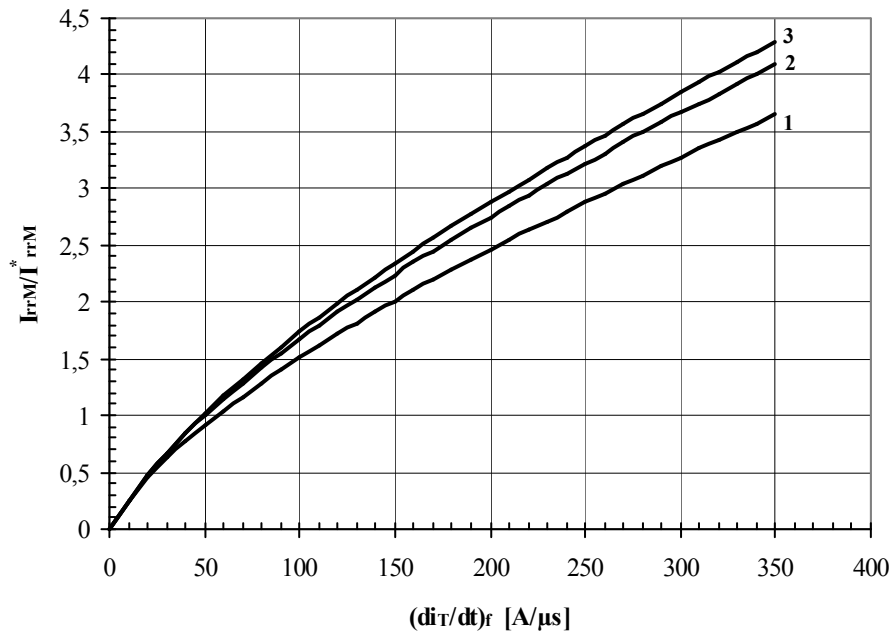
1 -  $I_{TM} = 0.5 I_{TAV}$

2 -  $I_{TM} = I_{TAV}$

3 -  $I_{TM} = 1.5 I_{TAV}$

Conditions:  $T_j = T_{jmax}$ ;  $V_R = 100$  V

Typical changes of  $t_{rr}$  are normalized to the  $t_{rr}^*$  ( $t_{rr}^*$  - see data sheet)



**Fig. 9** Peak reverse recovery current  $I_{rrM}$  vs. Rate of fall of on-state current  $di_R/dt$

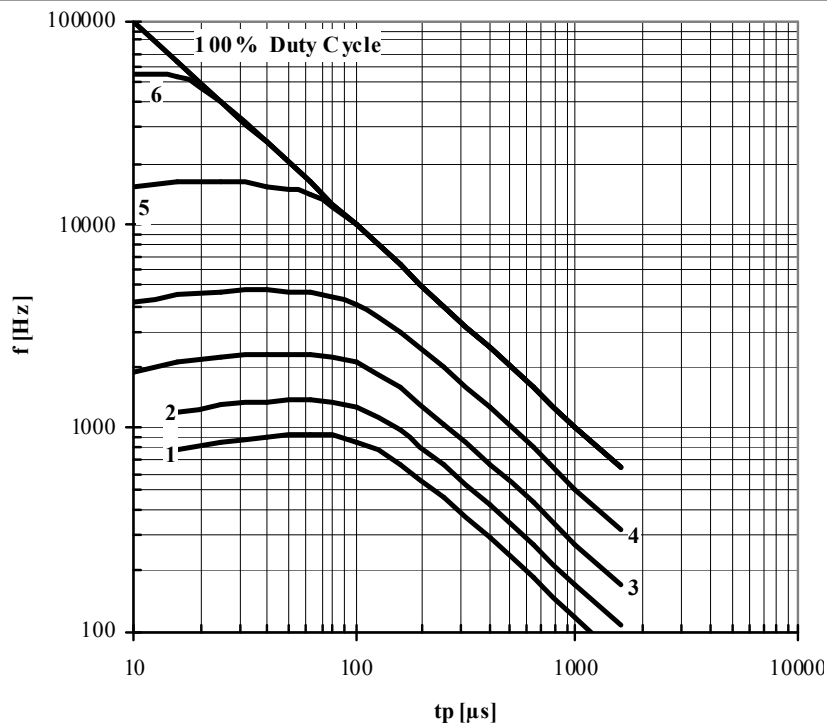
1 -  $I_{TM} = 0.5 I_{TAV}$

2 -  $I_{TM} = I_{TAV}$

3 -  $I_{TM} = 1.5 I_{TAV}$

Conditions:  $T_j = T_{jmax}$ ;  $V_R = 100$  V

Typical changes of  $I_{rrM}$  are normalized to the  $I_{rrM}^*$  ( $I_{rrM}^*$  - see data sheet)



**Fig. 10** Sine wave frequency ratings

1 -  $I_{TM} = 5000$  A

2 -  $I_{TM} = 4000$  A

3 -  $I_{TM} = 3000$  A

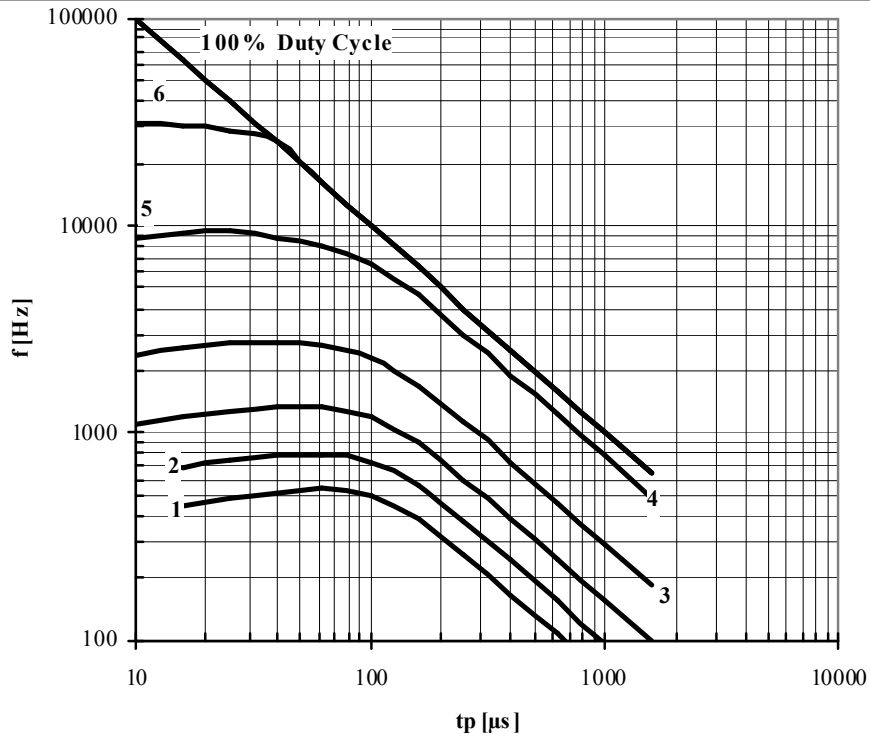
4 -  $I_{TM} = 2000$  A

5 -  $I_{TM} = 1000$  A

6 -  $I_{TM} = 500$  A



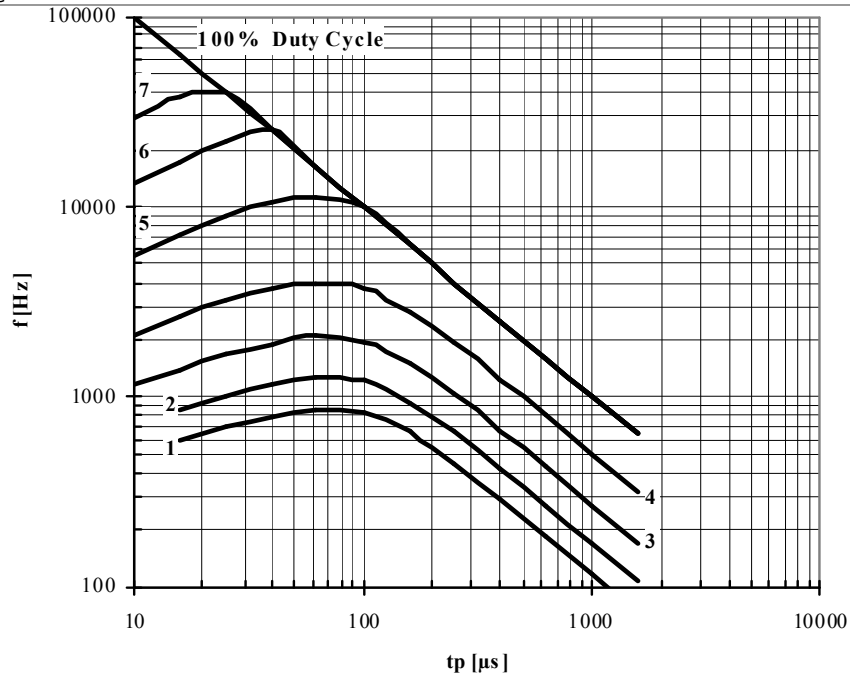
Conditions:  $V_R \leq 3 \text{ V}$ ;  $T_C = 55 \text{ }^\circ\text{C}$



**Fig. 11** Sine wave frequency ratings

- 1 -  $I_{TM} = 5000 \text{ A}$
- 2 -  $I_{TM} = 4000 \text{ A}$
- 3 -  $I_{TM} = 3000 \text{ A}$
- 4 -  $I_{TM} = 2000 \text{ A}$
- 5 -  $I_{TM} = 1000 \text{ A}$
- 6 -  $I_{TM} = 500 \text{ A}$

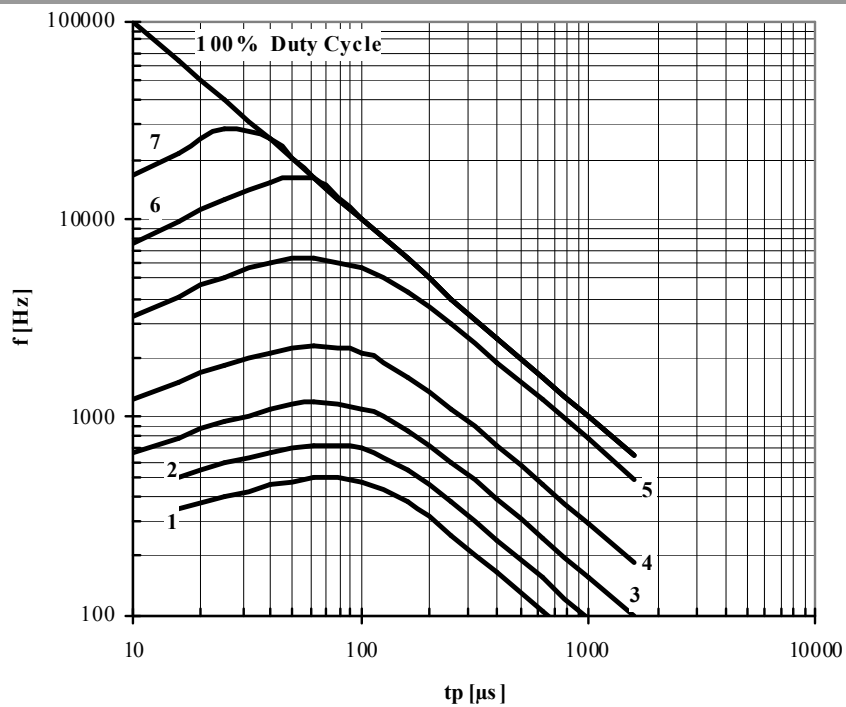
Conditions:  $V_R \leq 3 \text{ V}$ ;  $T_C = 90 \text{ }^\circ\text{C}$



**Fig. 12** Sine wave frequency ratings

- 1 -  $I_{TM} = 5000 \text{ A}$
- 2 -  $I_{TM} = 4000 \text{ A}$
- 3 -  $I_{TM} = 3000 \text{ A}$
- 4 -  $I_{TM} = 2000 \text{ A}$
- 5 -  $I_{TM} = 1000 \text{ A}$
- 6 -  $I_{TM} = 500 \text{ A}$
- 7 -  $I_{TM} = 250 \text{ A}$

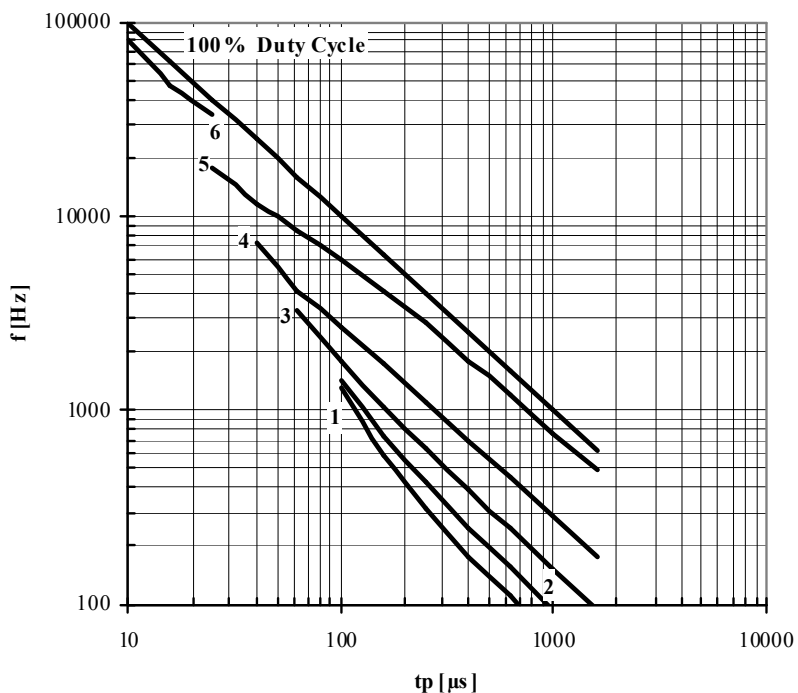
Conditions:  $V_R = 0.67 \cdot V_{RRM}$ ;  $T_C = 55 \text{ }^\circ\text{C}$



**Fig. 13** Sine wave frequency ratings

- 1 -  $I_{TM} = 5000$  A
- 2 -  $I_{TM} = 4000$  A
- 3 -  $I_{TM} = 3000$  A
- 4 -  $I_{TM} = 2000$  A
- 5 -  $I_{TM} = 1000$  A
- 6 -  $I_{TM} = 500$  A
- 7 -  $I_{TM} = 250$  A

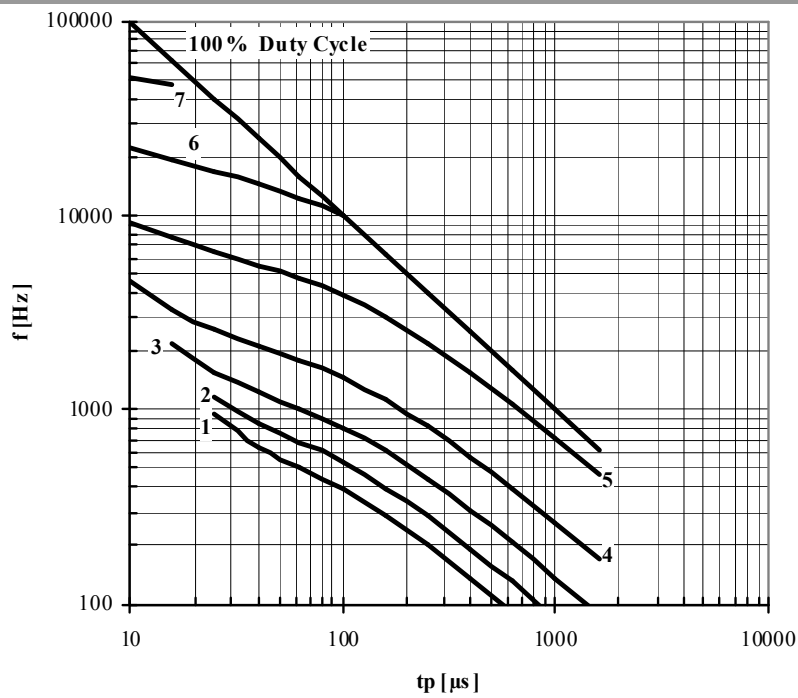
Conditions:  $V_R = 0.67 V_{RRM}$ ;  $T_C = 90$  °C



**Fig. 14** Square wave frequency ratings

- 1 -  $I_{TM} = 5000$  A
- 2 -  $I_{TM} = 4000$  A
- 3 -  $I_{TM} = 3000$  A
- 4 -  $I_{TM} = 2000$  A
- 5 -  $I_{TM} = 1000$  A
- 6 -  $I_{TM} = 500$  A

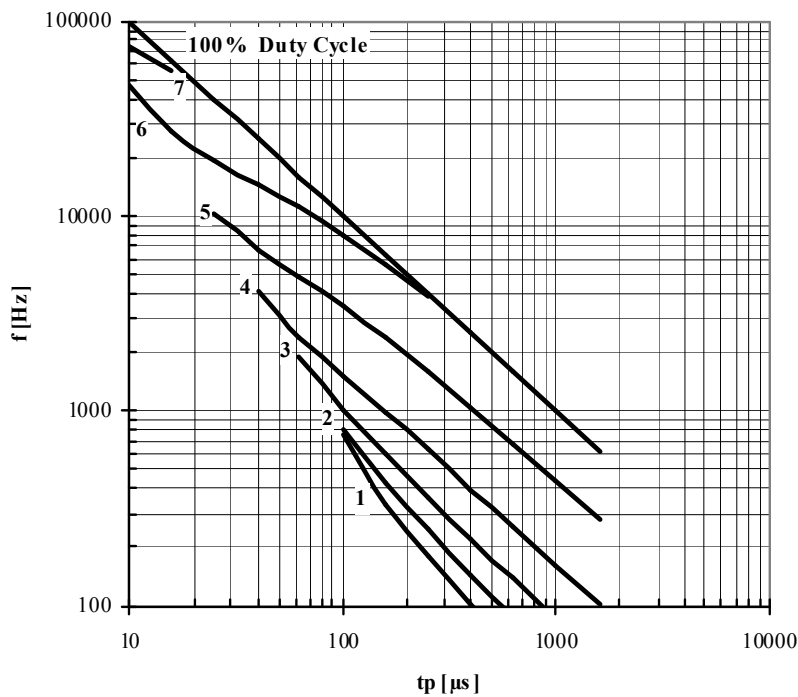
Conditions:  $V_R \leq 3$  V;  $T_C = 55$  °C;  $di_F/dt = di_R/dt = 100$  A/μs



**Fig. 15** Square wave frequency ratings

- 1 -  $I_{TM} = 5000$  A
- 2 -  $I_{TM} = 4000$  A
- 3 -  $I_{TM} = 3000$  A
- 4 -  $I_{TM} = 2000$  A
- 5 -  $I_{TM} = 1000$  A
- 6 -  $I_{TM} = 500$  A
- 7 -  $I_{TM} = 250$  A

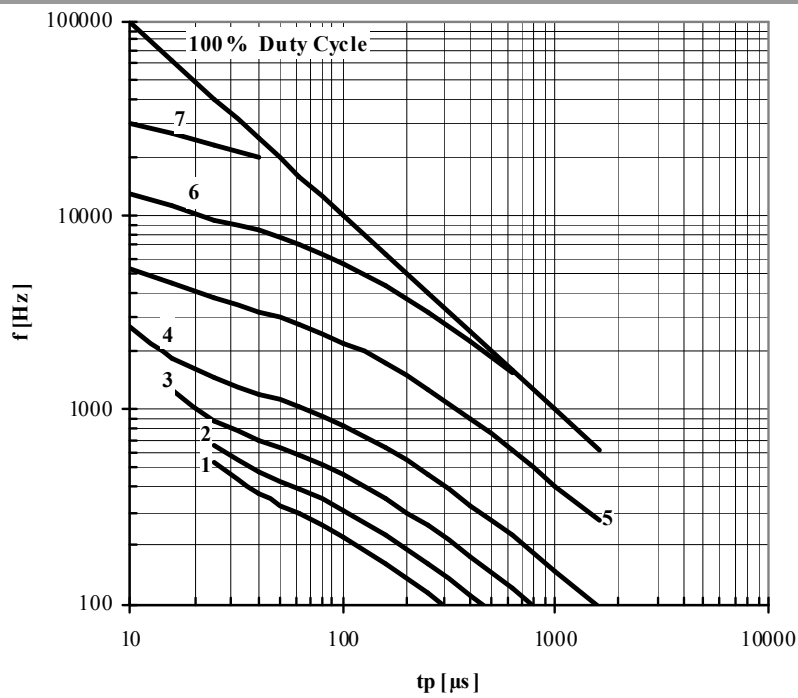
Conditions:  $V_R \leq 3$  V;  $T_C = 55$  °C;  $di_F/dt = di_R/dt = 500$  A/ $\mu$ s



**Fig. 16** Square wave frequency ratings

- 1 -  $I_{TM} = 5000$  A
- 2 -  $I_{TM} = 4000$  A
- 3 -  $I_{TM} = 3000$  A
- 4 -  $I_{TM} = 2000$  A
- 5 -  $I_{TM} = 1000$  A
- 6 -  $I_{TM} = 500$  A
- 7 -  $I_{TM} = 250$  A

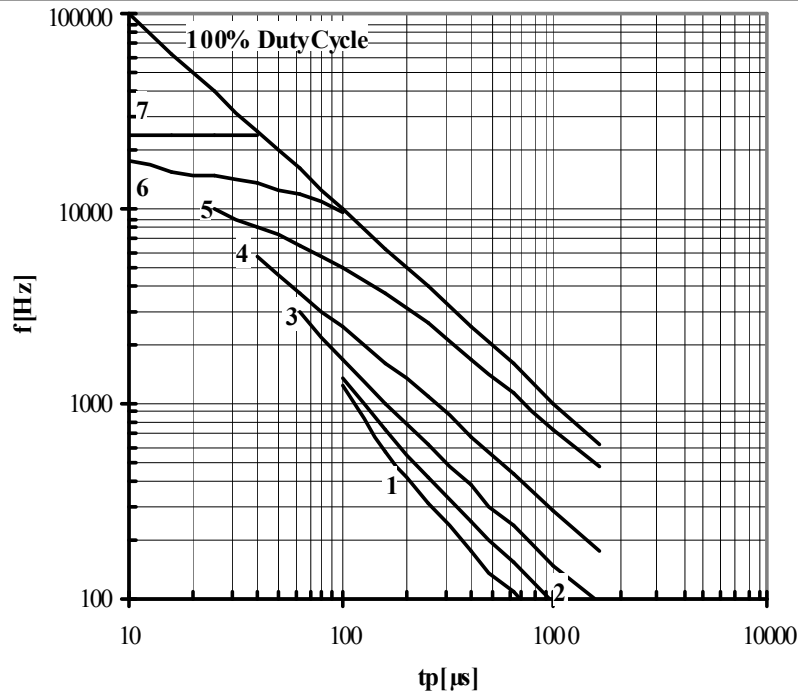
Conditions:  $V_R \leq 3$  V;  $T_C = 90$  °C;  $di_F/dt = di_R/dt = 100$  A/ $\mu$ s



**Fig. 17** Square wave frequency ratings

- 1 -  $I_{TM} = 5000$  A
- 2 -  $I_{TM} = 4000$  A
- 3 -  $I_{TM} = 3000$  A
- 4 -  $I_{TM} = 2000$  A
- 5 -  $I_{TM} = 1000$  A
- 6 -  $I_{TM} = 500$  A
- 7 -  $I_{TM} = 250$  A

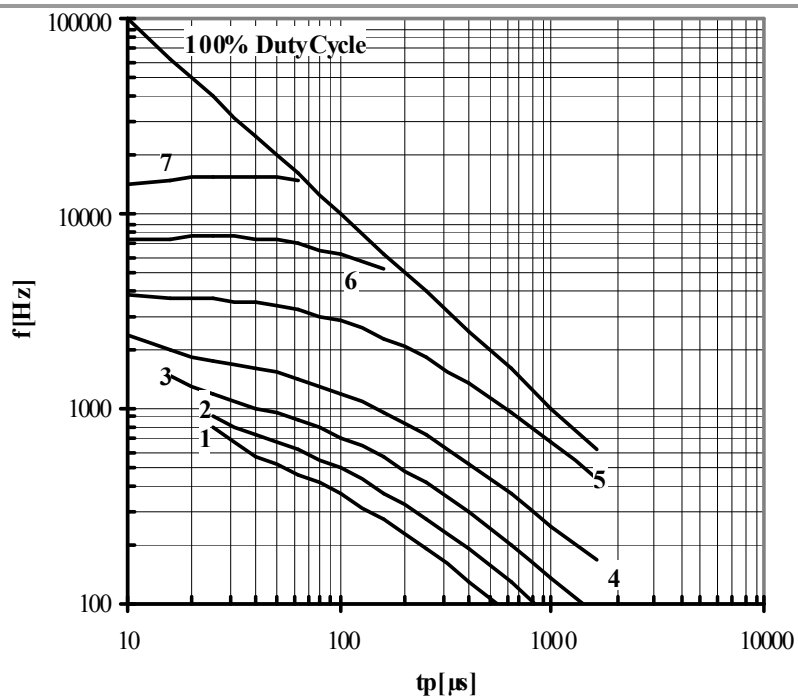
Conditions:  $V_R \leq 3$  V;  $T_C = 90$  °C;  $di_F/dt = di_R/dt = 500$  A/ $\mu$ s



**Fig. 18** Square wave frequency ratings

- 1 -  $I_{TM} = 5000$  A
- 2 -  $I_{TM} = 4000$  A
- 3 -  $I_{TM} = 3000$  A
- 4 -  $I_{TM} = 2000$  A
- 5 -  $I_{TM} = 1000$  A
- 6 -  $I_{TM} = 500$  A
- 7 -  $I_{TM} = 250$  A

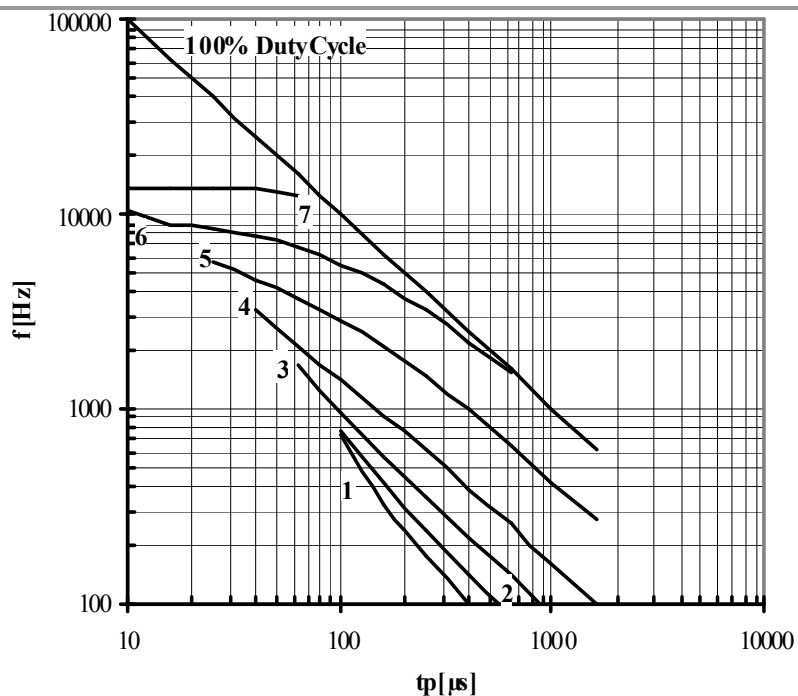
Conditions:  $V_R = 0.67 \cdot V_{RRM}$ ;  $T_C = 55$  °C;  $di_F/dt = di_R/dt = 100$  A/ $\mu$ s



**Fig. 19** Square wave frequency ratings

- 1 -  $I_{TM} = 5000$  A
- 2 -  $I_{TM} = 4000$  A
- 3 -  $I_{TM} = 3000$  A
- 4 -  $I_{TM} = 2000$  A
- 5 -  $I_{TM} = 1000$  A
- 6 -  $I_{TM} = 500$  A
- 7 -  $I_{TM} = 250$  A

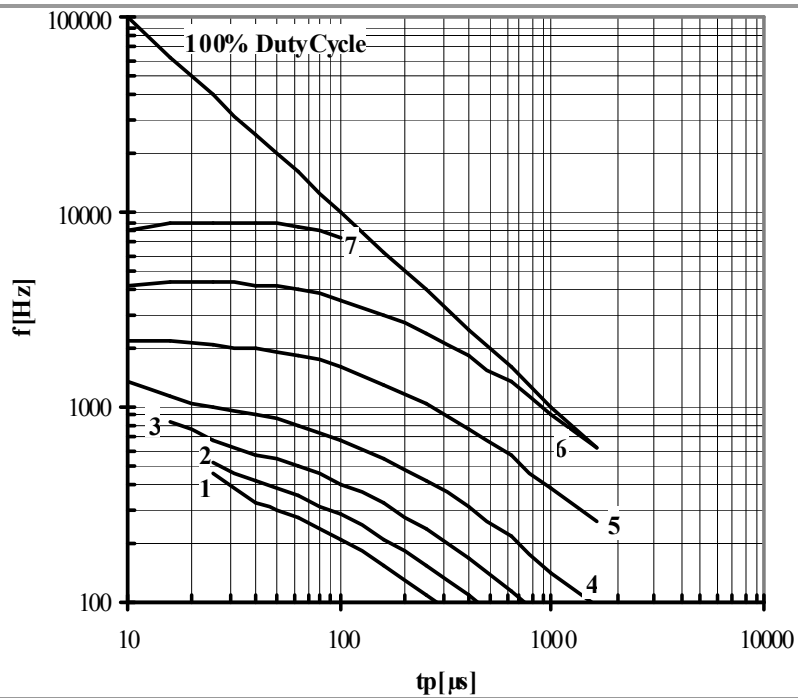
Conditions:  $V_R = 0.67 \cdot V_{RRM}$ ;  $T_C = 55$  °C;  $di_F/dt = di_R/dt = 500$  A/ $\mu$ s



**Fig. 20** Square wave frequency ratings

- 1 -  $I_{TM} = 5000$  A
- 2 -  $I_{TM} = 4000$  A
- 3 -  $I_{TM} = 3000$  A
- 4 -  $I_{TM} = 2000$  A
- 5 -  $I_{TM} = 1000$  A
- 6 -  $I_{TM} = 500$  A
- 7 -  $I_{TM} = 250$  A

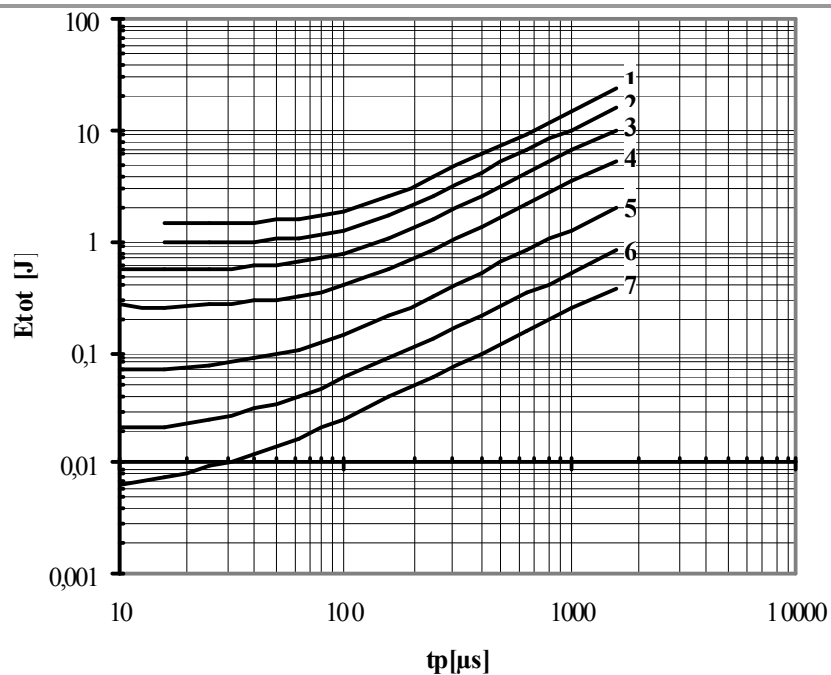
Conditions:  $V_R = 0.67 \cdot V_{RRM}$ ;  $T_C = 90$  °C;  $di_F/dt = di_R/dt = 100$  A/ $\mu$ s



**Fig. 21** Square wave frequency ratings

- 1 -  $I_{TM} = 5000$  A
- 2 -  $I_{TM} = 4000$  A
- 3 -  $I_{TM} = 3000$  A
- 4 -  $I_{TM} = 2000$  A
- 5 -  $I_{TM} = 1000$  A
- 6 -  $I_{TM} = 500$  A
- 7 -  $I_{TM} = 250$  A

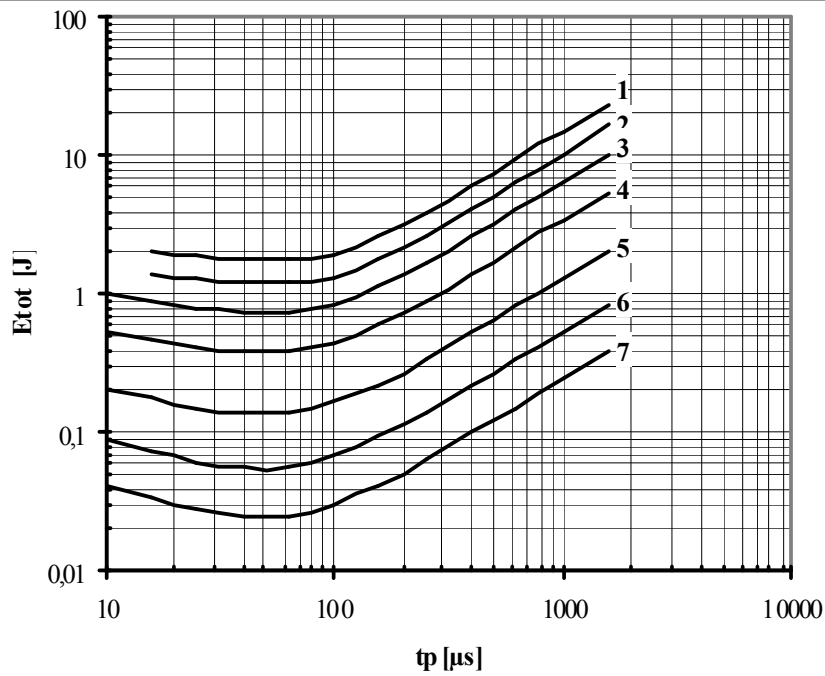
Conditions:  $V_R = 0.67 \cdot V_{RRM}$ ;  $T_C = 90$  °C;  $di_F/dt = di_R/dt = 500$  A/ $\mu$ s



**Fig. 22** Sine wave loss energy per pulse

- 1 -  $I_{TM} = 5000$  A
- 2 -  $I_{TM} = 4000$  A
- 3 -  $I_{TM} = 3000$  A
- 4 -  $I_{TM} = 2000$  A
- 5 -  $I_{TM} = 1000$  A
- 6 -  $I_{TM} = 500$  A
- 7 -  $I_{TM} = 250$  A

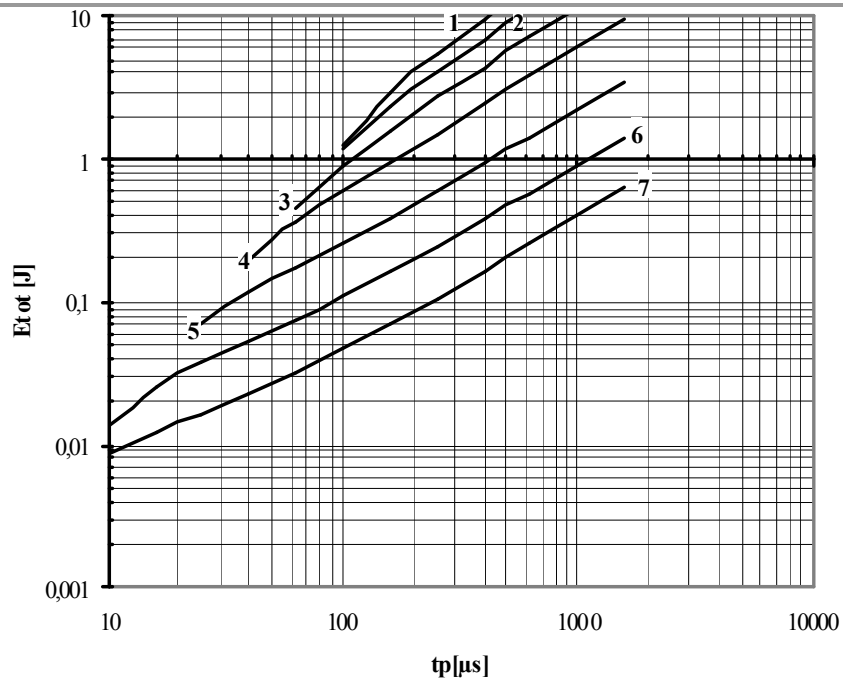
Conditions:  $V_R \leq 3$  V



**Fig. 23** Sine wave loss energy per pulse

- 1 -  $I_{TM} = 5000$  A
- 2 -  $I_{TM} = 4000$  A
- 3 -  $I_{TM} = 3000$  A
- 4 -  $I_{TM} = 2000$  A
- 5 -  $I_{TM} = 1000$  A
- 6 -  $I_{TM} = 500$  A
- 7 -  $I_{TM} = 250$  A

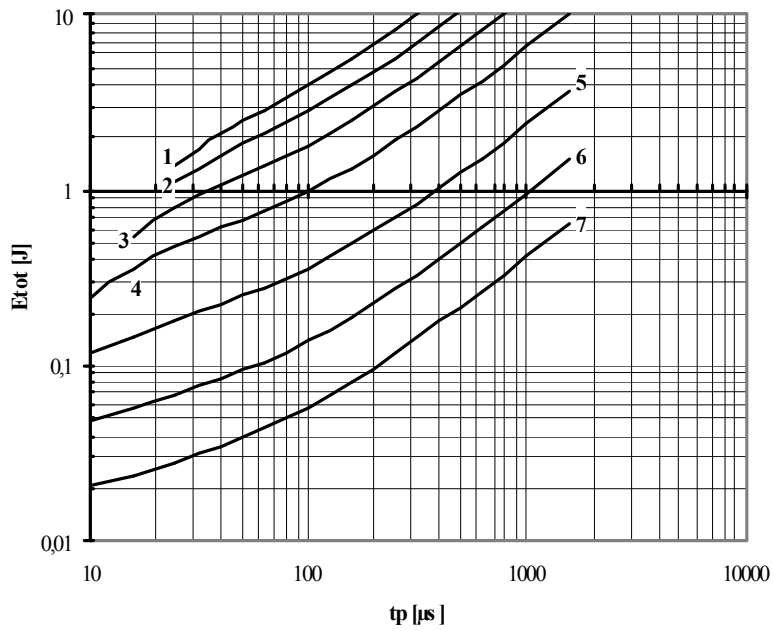
Conditions:  $V_R = 0.67 \cdot V_{RRM}$



**Fig. 24** Square wave loss energy per pulse

- 1 -  $I_{TM} = 5000$  A
- 2 -  $I_{TM} = 4000$  A
- 3 -  $I_{TM} = 3000$  A
- 4 -  $I_{TM} = 2000$  A
- 5 -  $I_{TM} = 1000$  A
- 6 -  $I_{TM} = 500$  A
- 7 -  $I_{TM} = 250$  A

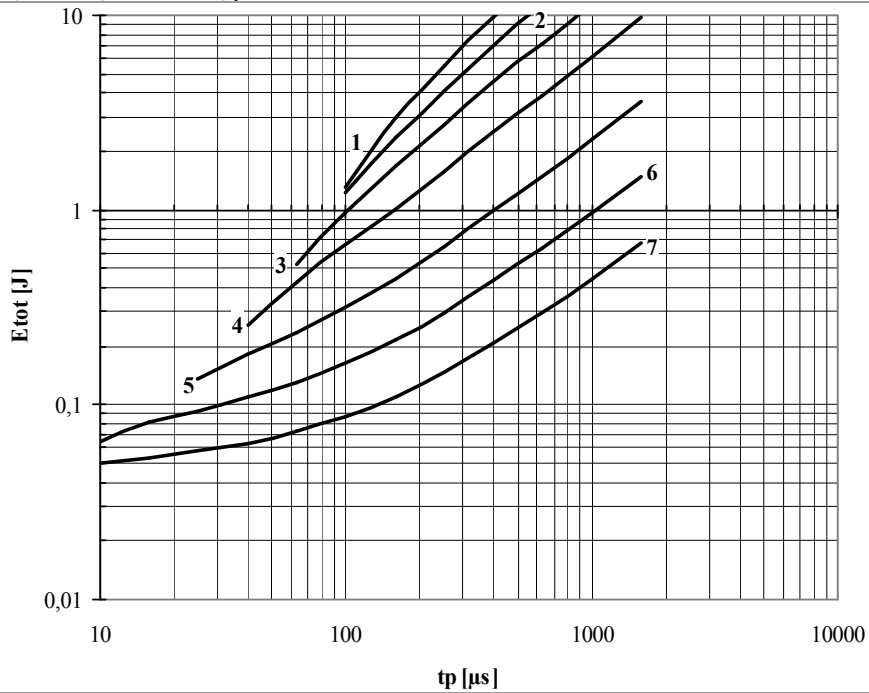
Conditions:  $V_R \leq 3$  V;  $di_F/dt = di_R/dt = 100$  A/ $\mu$ s



**Fig. 25** Square wave loss energy per pulse

- 1 -  $I_{TM} = 5000$  A
- 2 -  $I_{TM} = 4000$  A
- 3 -  $I_{TM} = 3000$  A
- 4 -  $I_{TM} = 2000$  A
- 5 -  $I_{TM} = 1000$  A
- 6 -  $I_{TM} = 500$  A
- 7 -  $I_{TM} = 250$  A

Conditions:  $V_R \leq 3$  V;  $di_F/dt = di_R/dt = 500$  A/ $\mu$ s

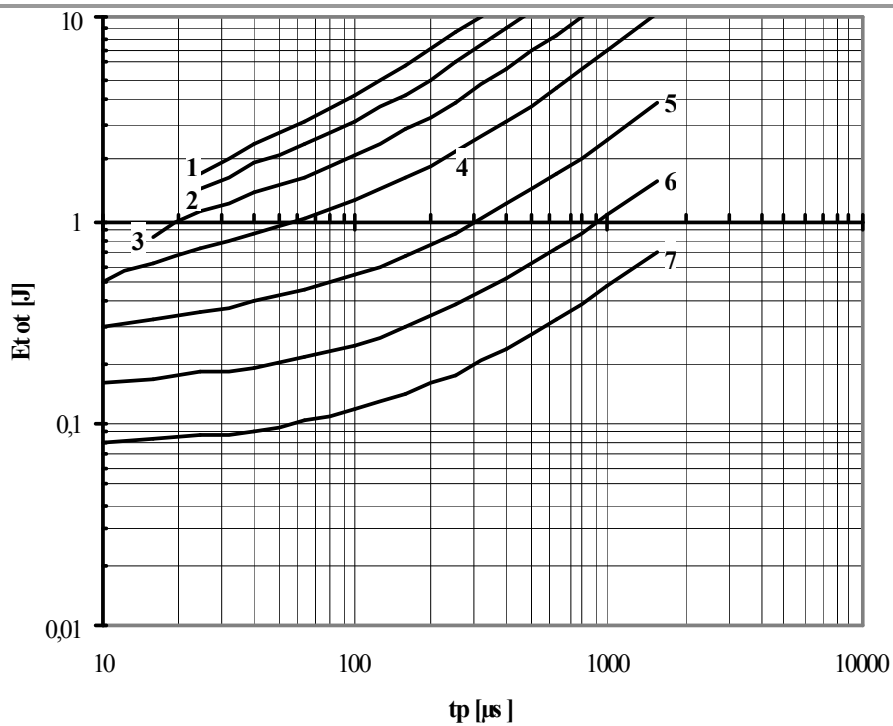


**Fig. 26** Square wave loss energy per pulse

- 1 -  $I_{TM} = 5000$  A
- 2 -  $I_{TM} = 4000$  A
- 3 -  $I_{TM} = 3000$  A
- 4 -  $I_{TM} = 2000$  A
- 5 -  $I_{TM} = 1000$  A
- 6 -  $I_{TM} = 500$  A
- 7 -  $I_{TM} = 250$  A

Conditions:  $V_R = 0.67 \cdot V_{RRM}$ ;  $di_F/dt = di_R/dt = 100$  A/ $\mu$ s

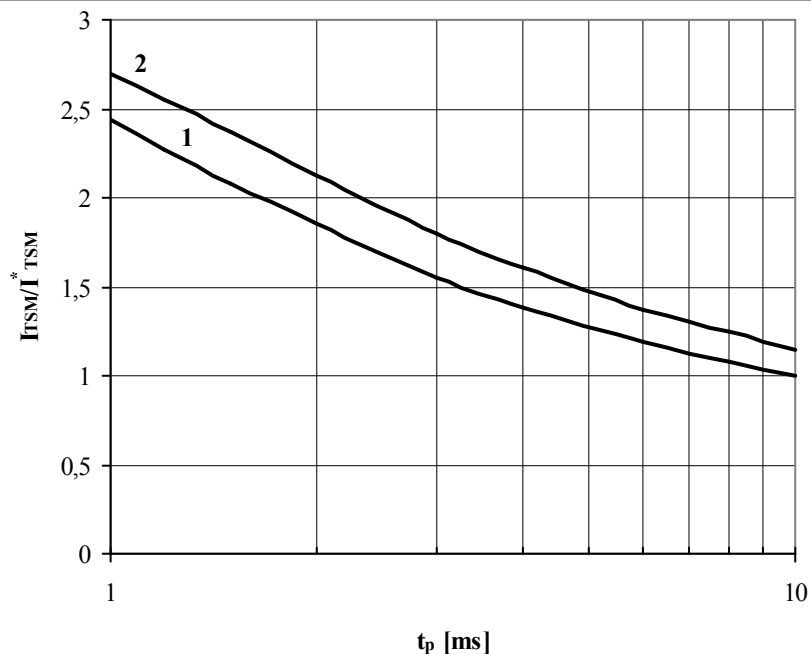




**Fig. 27** Square wave loss energy per pulse

- 1 -  $I_{TM} = 5000$  A
- 2 -  $I_{TM} = 4000$  A
- 3 -  $I_{TM} = 3000$  A
- 4 -  $I_{TM} = 2000$  A
- 5 -  $I_{TM} = 1000$  A
- 6 -  $I_{TM} = 500$  A
- 7 -  $I_{TM} = 250$  A

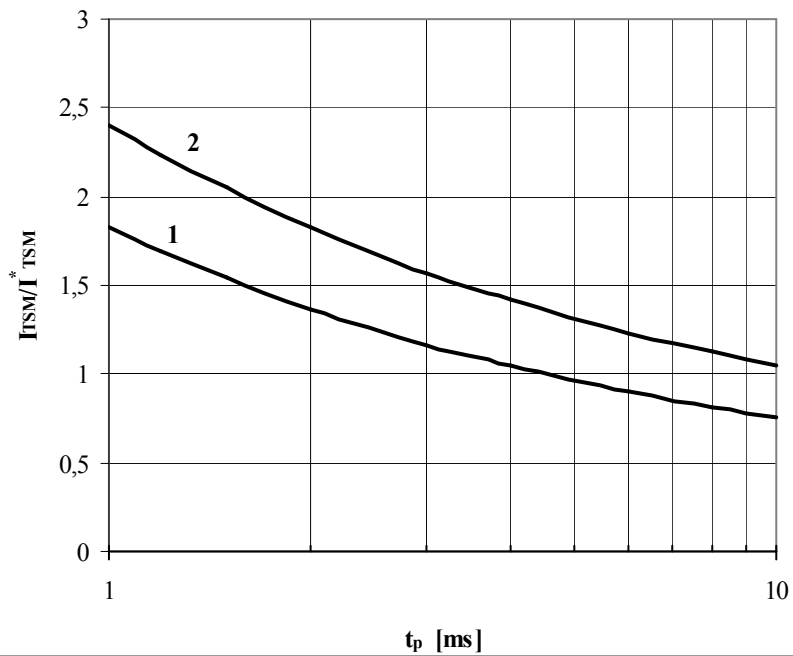
Conditions:  $V_R = 0.67 \cdot V_{RRM}$ ;  $di_F/dt = di_R/dt = 500$  A/ $\mu$ s



**Fig. 28** The surge current  $I_{TSM}$  vs. Duration of surge  $t_p$  for a half-sine wave

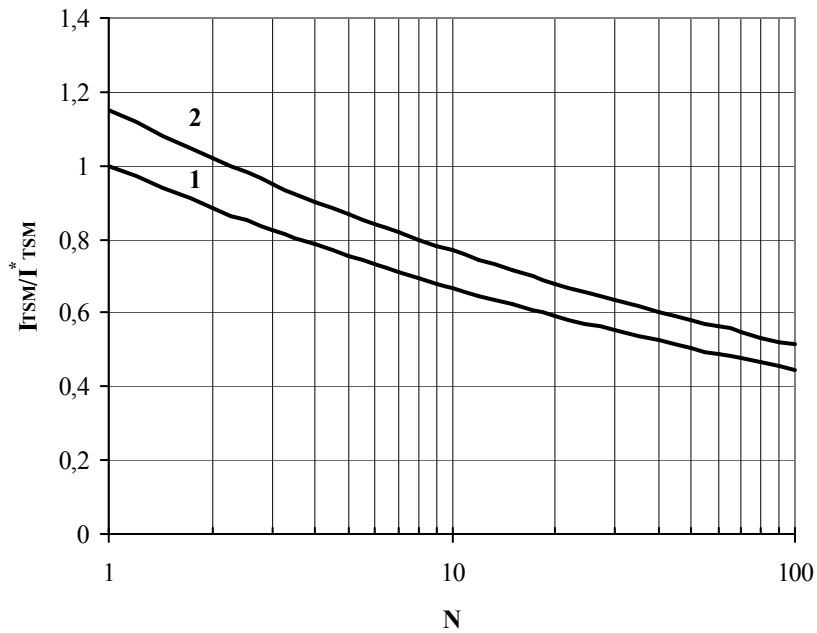
- 1 -  $T_j = 125$  °C
- 2 -  $T_j = 25$  °C

Conditions:  $V_R = 0$  V – the peak value of reverse voltage which is applied immediately after the surge current  
 Typical changes of  $I_{TSM}$  are normalized to the  $I_{TSM}^*$  ( $I_{TSM}^*$  – see data sheet,  $T_j = T_{j\max}$ )



**Fig. 29** The surge current  $I_{TSM}$  vs. Duration of surge  $t_p$  for a half-sine wave  
 1 –  $T_j = 125\text{ °C}$   
 2 –  $T_j = 25\text{ °C}$

Conditions:  $V_R = 0.8 \cdot V_{RRM}$  – the peak value of reverse voltage which is applied immediately after the surge current  
 Typical changes of  $I_{TSM}$  are normalized to the  $I_{TSM}^*$  ( $I_{TSM}^*$  – see data sheet,  $T_j = T_{j\text{ max}}$ )

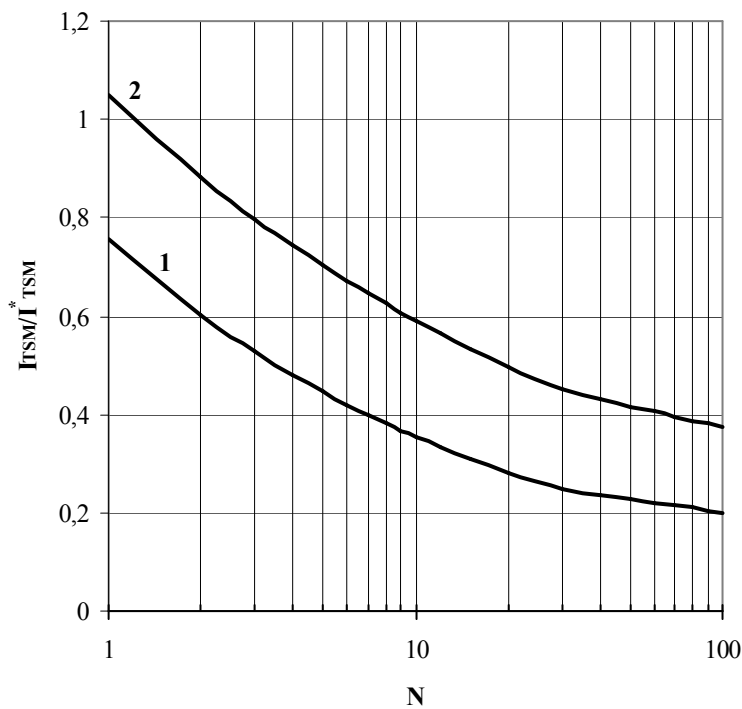


**Fig. 30** The surge current  $I_{TSM}$  vs. Number of half-sine waves at 50 Hz

1 –  $T_j=125^\circ\text{C}$

2 –  $T_j=25^\circ\text{C}$

Conditions:  $V_R=0\text{ V}$  – the peak value of reverse voltage which is applied immediately after the surge current  
 Typical changes of  $I_{TSM}$  are normalized to the  $I_{TSM}^*$  ( $I_{TSM}^*$  – see data sheet,  $T_j=T_{j\text{ max}}$ )



**Fig. 31** The surge current  $I_{TSM}$  vs. Number of half-sine waves at 50 Hz

1 –  $T_j=125^\circ\text{C}$

2 –  $T_j=25^\circ\text{C}$

Conditions:  $V_R=0.8 \cdot V_{RRM}$  – the peak value of reverse voltage which is applied immediately after the surge current  
 Typical changes of  $I_{TSM}$  are normalized to the  $I_{TSM}^*$  ( $I_{TSM}^*$  – see data sheet,  $T_j=T_{j\text{ max}}$ )